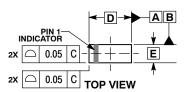
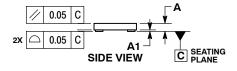
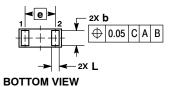


DSN2, 1.4x0.6, 1.00P (0502) CASE 152AU ISSUE A

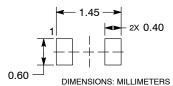
DATE 08 JUN 2016







RECOMMENDED MOUNTING FOOTPRINT*



See Application Note AND8464/D for more mounting details

NOTES:

- DIMENSIONING AND TOLERANCING PER
 ASME Y14.5M. 1994.
- 2. CONTROLLING DIMENSION: MILLIMETERS.

	MILLIMETERS		
DIM	MIN	MAX	
Α	0.25	0.31	
A1	0.00	0.05	
b	0.45	0.55	
D	1.40 BSC		
E	0.60 BSC		
е	1.00 BSC		
L	0.20	0.30	

GENERIC MARKING DIAGRAM1*



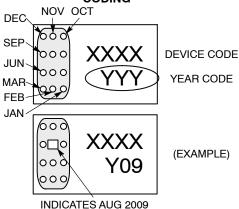
GENERIC
MARKING DIAGRAM2*



XXXX = Specific Device Code YYY = Year Code XX = Specific Device Code
M = Date Code

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G", may or not be present.

CATHODE BAND MONTH CODING



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DESCRIPTION:	DSN2, 1.4X0.6, 1.00P (0502)		PAGE 1 OF 1

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^{*}For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.